

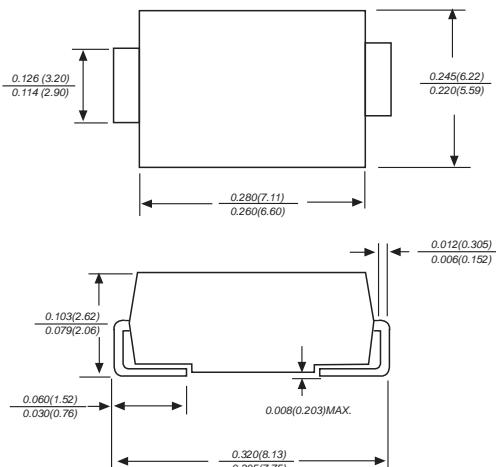


US5A THRU US5M

SURFACE MOUNT ULTRA FAST RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current - 5.0 Amperes

DO-214AB/SMC



Dimensions in inches and (millimeters)

FEATURES

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low reverse leakage
- ◆ Built-in strain relief, ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed: 250°C/10 seconds at terminals
- ◆ Glass passivated chip junction

MECHANICAL DATA

Case : JEDEC DO-214AB molded plastic body over passivated chip
Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Color band denotes cathode end

Mounting Position : Any

Weight : 0.007 ounce, 0.25grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load derate by 20%.

MDD Catalog Number	SYMBOLS	US5A	US5B	US5D	US5G	US5J	US5K	US5M	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	VOLTS
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	VOLTS
Maximum DC blocking voltage	V _{Dc}	50	100	200	400	600	800	1000	VOLTS
Maximum average forward rectified current at T _L =55°C	I _(AV)				5.0				Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}				100.0				Amps
Maximum instantaneous forward voltage at 5.0A	V _F		1.0		1.4		1.7		Volts
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =100°C	I _R				10.0				µA
					300.0				
Maximum reverse recovery time (NOTE 1)	t _{rr}		50			75			ns
Typical junction capacitance (NOTE 2)	C _J		15			12			pF
Typical thermal resistance (NOTE 3)	R _{θJA}			15.0					°C/W
Operating junction and storage temperature range	T _J , T _{STG}		-50 to +150						°C

Note: 1. Reverse recovery condition I_F=0.5A, I_R=1.0A, I_{rr}=0.25A

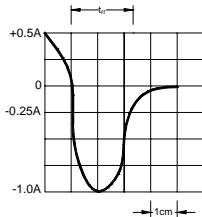
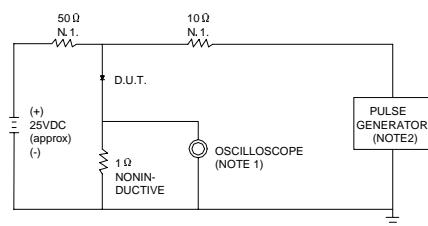
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

3. P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas



RATINGS AND CHARACTERISTIC CURVES US5A THRU US5M

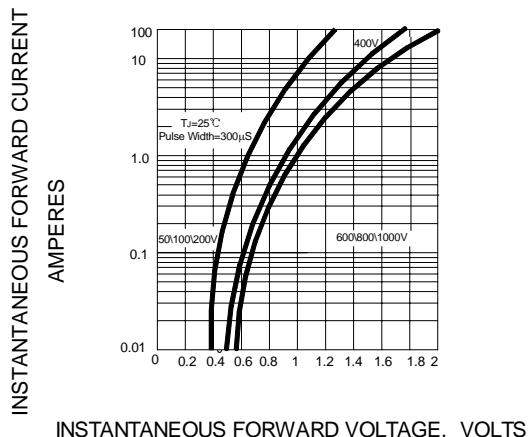
FIG.1 – TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



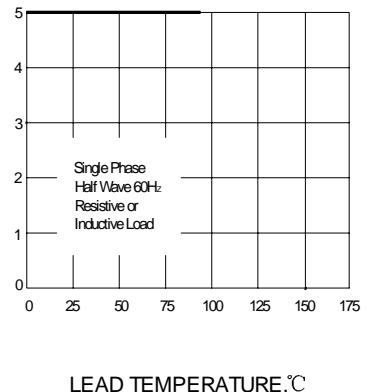
NOTES:
1. RISE TIME = 7ns MAX INPUT IMPEDANCE = 1MΩ .22pF.
2. RISE TIME = 10ns MAX SOURCE IMPEDANCE = 50 Ω.

SET TIME BASE FOR 20/30 ns/cm

FIG.2 – TYPICAL FORWARD CHARACTERISTIC

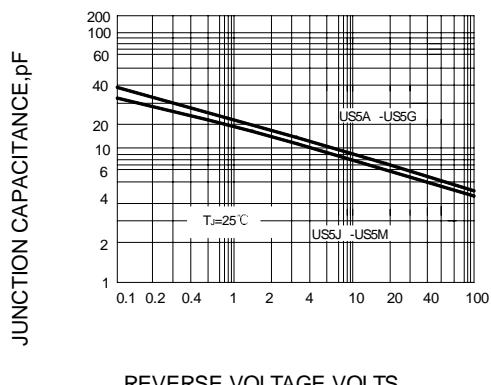


AVERAGE FORWARD CURRENT
AMPERES

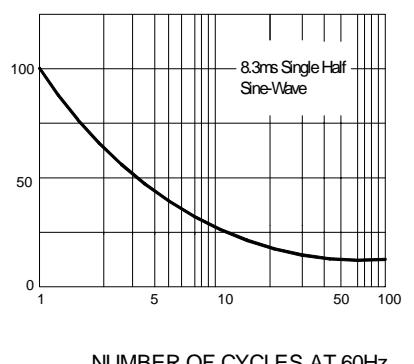


LEAD TEMPERATURE, °C

FIG.4 – TYPICAL JUNCTION CAPACITANCE



PEAK FORWARD SURGE CURRENT
AMPERES



The curve graph is for reference only, can't be the basis for judgment(曲线图仅供参考)!

